Formation of Al-Ni Intermetallic Layers Lining Microchannels Produced by Powder-Metallurgical Process Using Aluminum Sacrificial Cores

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The mechanism of in-situ formation of Al-Ni intermetallic lining layers during microchannel formation in nickel bodies by a powder-metallurgical process has been investigated. Aluminum wire was used as a sacrificial core that gives the shape of the microchannel and supplies the alloying element for the lining layer. Nickel powder compacts with 29(±1)% porosity containing aluminum wires were heated from room temperature and then quenched at various temperatures between 873 K and 1473 K. Porous intermetallic lining layers were clearly recognized at temperatures above 1073 K. Each lining layer was built up from an outward-growing layer and an inward-growing layer. Change in the voidage in the outward-growing layer during heat treatment and the formation of a high-voidage zone around the lining layer were accounted for in terms of phase equilibria and unequal diffusion rates of the alloy elements in the Al-Ni intermetallic compounds and nickel solid solution.


(Received June 3, 2016; Accepted August 10, 2016; Published September 16, 2016)

Keywords: microchannel device, microchannel heat exchanger, microreactor, microchannel lining, microporous structure, intermetallic compound, nickel aluminide, powder metallurgy, unequal diffusion rates, Kirkendall voids

1. Introduction

Development of high-efficiency heat exchangers is one of main issues in a wide range of technological fields including industrial waste heat recovery and thermal management of high-power microelectronic devices. In recent years, microchannel devices such as microreactors1–13) and microchannel heat sinks14–18) have actively been investigated with attention on the excellent heat exchange capability coming from the high surface to volume ratio of the microchannel structure. The heat exchange capability is one of the essential properties in the microreactor systems for precise control of reaction temperatures and effective use of heat from external sources. Metallic microchannel devices particularly provide superior heat transfer performance by combining the microchannel structure and the material with good heat conductivity. In addition, the metallic materials are better adapted to high-temperature applications because of their good heat resistance and ease of property control by means of alloying.

Several powder-metallurgical processes have been investigated to produce microchannels directly in metal bodies with simple operations.19–25) The space-holder method19–21) using evaporative or soluble patterns of microchannel space (so-called space-holders) produces microchannels in sintered metals. Resins were considered to be used for the evaporative space-holders which were removed by heating during the sintering process.19) Metallic space-holders soluble in a dilute acid or alkaline solution were also examined: they were removed chemically or electrochemically at room temperature before or after the sintering process.20,21)

The sacrificial-core method22–25) also uses metallic patterns of microchannel space. However, the metallic patterns in this method are not removed but used as the source of the alloying element(s) of lining layers surrounding the microchannels, and thus they are called sacrificial cores. Figure 1 illustrates the concept of this method. The metal to compose the device body, the body metal, has higher melting point than that making up the sacrificial core, the sacrificial-core metal. A body-metal powder compact containing a sacrificial core is sintered at temperatures between the melting points of these metals. During sintering, molten sacrificial-core metal migrates to the body-metal powder region by infiltration and/or diffusion to produce a microchannel and an alloy lining layer simultaneously. The formation behaviors of the microchannel and also the structure and composition of the lining layer would vary according to the combination of the body metal and the sacrificial-core metal as well as the process conditions of powder compaction and sintering. If the lining layers acquire various functions through this process and additional simple post processes as appropriate, low-cost production of high-performance microchannel devices becomes reality.

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Figure 2 shows a typical structure of the lining layer produced by the sacrificial-core method with a combination of nickel (body metal) and aluminum (sacrificial-core metal). The lining layer mainly consists of NiAl and has a peculiar porous structure in which long and thin micropores have grown along the thickness direction of the lining layer. Such a porous structure of the inner wall of the microchannel is expected to improve flow boiling stability and enhance convective heat transfer. In addition, the NiAl intermetallic compound has a high thermal conductivity, good heat resistance and excellent corrosion resistance. On the other hand, many fine voids are observed near the boundary between the lining layer and the sintered body-metal region. These outer circumferential voids are considered undesirable for the heat transfer performance of the microchannel devices. However, the guidelines for controlling such structures have not been established because the formation mechanism of the Al-Ni intermetallic lining layer is still unclear. In the present study, therefore, we investigated the formation process of the Al-Ni intermetallic lining layer during sintering, especially focusing on the changes in its growing rate, constituting phase(s) and porous structure.

2. Experimental Procedure

In order to investigate the structure change of the lining layer during sintering, we conducted quenching experiments using nickel powder compacts containing aluminum sacrificial cores. The average diameter of the nickel powder particles was 5 µm. The shape of the sacrificial core was a straight wire 10 mm in length and 100, 200 or 500 µm in diameter (d). In the present paper, results of the 500 µm-diameter sacrificial core are examined. Those of the other sacrificial cores will be referred to in the future papers. The purity of the nickel powder was 99.8 mass%, and that of the aluminum wire was 99.98 mass%. Thirteen grams of nickel powder and three aluminum sacrificial cores with different diameters were cold-pressed into a cylindrical green compact in a metal mold using a unidirectional pressure of 460 MPa. The resulted green compact had a diameter of 20 mm and nominal height of 5 mm, and its porosity, E, was 29(±1)%.

3. Results and Discussion

3.1 Structure evolution around the microchannel

Figure 5 presents back-scattered electron images of the
structures near the outer periphery of the former sacrificial-core region in the quenched specimens 29(±1)% in green compact porosity. The solid lines on each photograph are the approximate ellipses of the outer and inner peripheries of the lining layer; the dashed line is the ellipse fitted to the outer periphery of the sacrificial core before melting and superimposed concentrically. As shown in Fig. 5(b), the lining layer grew both outward and inward from the initial boundary between the sacrificial core and the body-metal region. The constituent phases of the outward-growing layer and the inward-growing layer at 1073 K were Al$_3$Ni$_2$ and Al$_3$Ni, respectively. The Al$_3$Ni phase is in equilibrium with the Al-rich liquid in the temperature range of 912.9–1127 K according to the phase diagram in Fig. 4. The Al$_3$Ni$_2$ phase was reported as the dominant reaction phase between Al and Ni in the diffusion experiments at various temperatures, e.g., 773 K$^{28}$ and 973–1373 K$^{29}$. In the specimen quenched at 1473 K in Fig. 5(e), the constituent phase of the lining layer had changed to Al-rich NiAl (NiAl$_{Al}$), and a Ni-rich NiAl (NiAl$_{Ni}$) layer and the outer circumferential voids began to grow near the outer periphery of the lining layer. In addition, a thin Ni$_3$Al layer was detected on the outer side of the peripheral void zone. In the furnace-cooled specimen in Fig. 5(f), many voids are distributed in the outer side of the Ni$_3$Al layer as well as in the inner side. For the constitution of the Ni$_3$Al layer, it should be noted that the layer often separates into the NiAl$_{Al}$ and NiAl$_{Ni}$ sublayers. Such a pseudo phase separation is caused by a non-proportional composition dependence of the diffusion coefficient in the NiAl phase.$^{25}$

3.2 Growth behavior of the lining layer

Figure 6 quantitatively indicates the growth behavior of the lining layer obtained from the specimens presented in Fig. 5. The vertical axis of the graph indicates the displacement of the inner or outer periphery of the lining layer from the Kirkendall interface i.e., the initial boundary between the sacrificial core and the body-metal region. The displacement was calculated by subtracting the mean radius of the approximate ellipse of the Kirkendall interface from that of the outer (or inner) periphery of the lining layer. The horizontal axis of the graph indicates the quenching temperatures for the quenched specimens and the top temperature for the furnace-cooled
specimen. The temperature range of the phases constituting the lining layers are also shown in the graph, which was based on the structure observation in Fig. 5 and the phase diagram in Fig. 4. As Fig. 6 shows, the growth rate of the outward-growing layer drastically increased after the lining layer had become almost single phase of Al$_3$Ni$_2$, and it decreased after the microchannel had completed at about 1273 K. It is well known that the diffusion rate of aluminum is higher than nickel in the Al-rich Al-Ni intermetallic compounds i.e., Al$_3$Ni, Al$_3$Ni$_2$, NiAl$_{3-32}$) Especially in Al$_3$Ni and Al$_3$Ni$_2$, aluminum atoms dominate the diffusion process. 31) In addition, the fact that Al$_3$Ni$_2$ is the dominant reaction phase between Al and Ni in its thermodynamically stable temperature range indicates that the diffusion rate in Al$_3$Ni$_2$ is higher than any of the other Al-Ni intermetallic compounds. The formation of the microchannel can thus be attributed to the rapid outward diffusion of aluminum through the Al$_3$Ni$_2$ single phase lining layer.

However, the inward growth of the lining layer can not be negligible as seen in Fig. 6. It will be a critical problem particularly for the case of much thinner sacrificial cores. Ohmi et al.23) reported that a thick intermetallic layer obstructed the microchannel when formed from a thin aluminum wire (50 µm in diameter) in a nickel (or iron) specimen sintered at a constant heating rate of 0.2 Ks$^{-1}$ from room temperature to 1473 K.23) They also showed that open microchannels were produced when another heating pattern was employed: rapid heating at 2 Ks$^{-1}$ from room temperature to 983 K and slow heating of 0.2 Ks$^{-1}$ from 983 K to 1473 K.23) For their results, one possible explanation can be given from the above concept of quasi-isothermal solidification. Figure 7 illustrates changes with time in nickel solubility in the Al-rich liquid during sintering with various heating patterns, which was inferred from the above experimental findings and previous diffusion studies33–35). As shown in Fig. 7, the rate of aluminum diffusion from the molten sacrificial core to the outward-growing layer in the early stage is higher than that of nickel diffusion in the opposite direction. The lower voidage of the outward-growing layer in the early stage can be explained by such unequal diffusion rates. In Fig. 9(b) which demonstrates the stage after the decomposition of Al$_3$Ni to Al$_3$Ni$_2$ and Al-rich liquid at 1127 K and the subsequent microchannel formation, the dominant diffusion of aluminum from the lining layer to the body-metal region...
leads to the drastic increase in voidage of the lining layer. Figure 9(c) corresponds to the stage after the decomposition of Al₃Ni to Al₃Ni₂ and Al-rich liquid at 1406 K. According to the results of Ni/Ni₃Al diffusion-couple experiments, a Ni₃Al layer grows towards the Ni₃Al region. This can be attributed to the dominant nickel diffusion from Ni₃Al towards the NiAlNi region. In the Ni/Ni₃Al diffusion couple, on the other hand, a layer of nickel solid solution grows towards the Ni₃Al region. Watanabe et al. described that Kirkendall voids were visible exclusively in the new nickel solid solution layer. They also pointed out that their result indicated that aluminum diffusion was faster than nickel diffusion in the disordered nickel solid solution.

It is to be noted that the outer periphery of the lining layer was set at the boundary between the NiAl (NiAlNi + NiAlAl) layer and the circumferential high-voidage zone as depicted in Figs. 5(e) and 5(f). Therefore, the influx of nickel atoms into the inner NiAlNi region in Fig. 9(d), which corresponds to the NiAlAl sublayer, can decrease the voidage of the region and thus that of the outward-growing layer. This corollary prediction is consistent with the result in Fig. 8. Furthermore, the inward influx of nickel atoms can extend the NiAlNi sublayer towards the NiAlAl sublayer as illustrated in Fig. 9(d).

3.4 Influence of the green compact porosity on the structures of the lining layer and the circumferential high-voidage zone

The above unsteady topical diffusion in the lining layer is eventually to shift to a quasi-steady state diffusion, in which one-way outward diffusion of aluminum and inward diffusion of nickel promote the growth of the NiAlNi sublayer. Figure 10 presents the relationship between the sublayer-thickness ratio, η (= wNi/wAl, where wNi and wAl are the average widths of the NiAlNi and NiAlAl sublayers, respectively), and the green compact porosity, E, obtained by the furnace-cooling experiments. According to this result, η has a positive correlation with E when E is below a certain critical level of about 26%, and becomes almost constant when E is over the critical level. This tendency can be explained as follows.
core region, and the latter by reactive diffusion of aluminum into the nickel powder region.

(2) The changes in the major constituting phase and the voidage in the outward-growing layer can be accounted for in terms of phase equilibria and unequal diffusion rates of aluminum and nickel in the Al-Ni intermetallic compounds.

(3) A high heating rate leads to a rapid increase in nickel solubility in the molten sacrificial core, and thus suppresses the inward growth of the intermetallic layer which is to obstruct the microchannel in the case of the small-diameter sacrificial core.

(4) The origin of the circumferential high-voidage zone is the Ni₃Al region temporarily formed in the outer side of the NiAl lining layer; Kirkendall voiding occurred in this region.

(5) A high green compact porosity leads to formation of a great amount of voids in the circumferential high-voidage zone. The high-voidage zone prominently developed is to block the diffusion of nickel from the body-metal region to the NiAl lining layer, and thus the further growth of the NiAl₃ sublayer.

Acknowledgement

This work was partly supported by a grant from the JFE 21 Century Foundation and KAKENHI (C) (19560740).

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